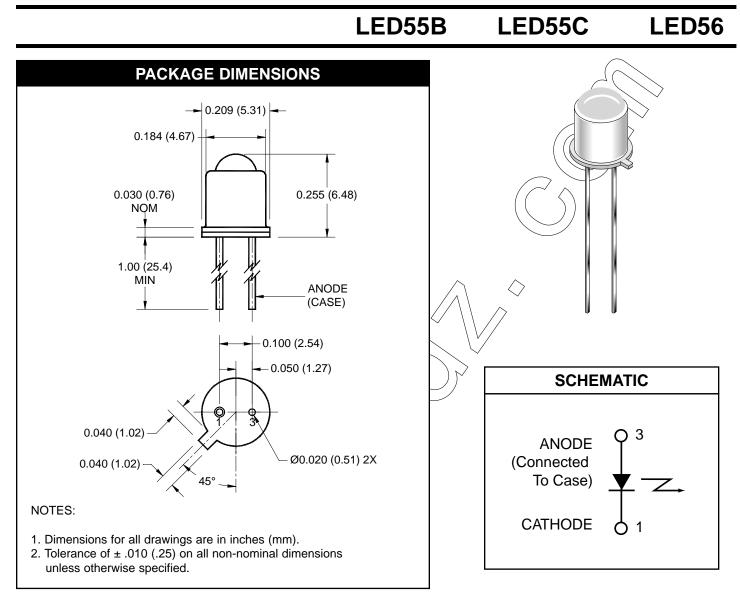
GaAs INFRARED EMITTING DIODE





DESCRIPTION

The LED55B/LED55C/LED56 are 940 nm LEDs in a narrow angle, TO-46 package.

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FEATURES

- Good optical to mechanical alignment
- Mechanically and wavelength matched to the TO-18 series phototransistor
- Hermetically sealed package
- High irradiance level



SEMICONDUCTOR®

LED55B LED55C LED56

1.3

Unit °C

°C

°C

°C

mΑ

А

V

mW

W

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C unless otherwise specified) Rating Parameter Symbol **Operating Temperature** -65 to +125 T_{OPR} -65 to +150 Storage Temperature T_{STG} Soldering Temperature (Iron)(3,4,5 and 6) 240 for 5 sec T_{SOL-I} Soldering Temperature (Flow)(3,4 and 6) 260 for 10 sec T_{SOL-F} **Continuous Forward Current** 100 I_F Forward Current (pw, 1µs; 200Hz) 10 I_{F} **Reverse Voltage** 3 V_R P_D Power Dissipation $(T_A = 25^{\circ}C)^{(1)}$ 170

NOTE:

1. Derate power dissipation linearly 1.70 mW/°C above 25°C ambient.

2. Derate power dissipation linearly 13.0 mW/°C above 25°C case.

3. RMA flux is recommended.

Power Dissipation (T_C = 25°C)⁽²⁾

- 4. Methanol or isopropyl alcohols are recommended as cleaning agents.
- 5. Soldering iron tip 1/16" (1.6mm) minimum from housing.
- 6. As long as leads are not under any stress or spring tension
- 7. Total power output, P_O, is the total power radiated by the device into a solid angle of 2 π steradians.

ELECTRICAL / OPTICAL CHARACTERISTICS (T _A =25°C) (All measurements made under pulse conditions)						
Peak Emission Wavelength	I _F = 100 mA	λ_{P}	—	940	—	nm
Emission Angle at 1/2 Power	I _F = 100 mA	θ	—	±8	—	Deg.
Forward Voltage	I _F = 100 mA	V _F	—	—	1.7	V
Reverse Leakage Current	V _R = 3 V	I _R	—	—	10	μA
Total Power LED55B(7)	I _F = 100 mA	Po	3.5	—	—	mW
Total Power LED55C ⁽⁷⁾	I _F = 100 mA	Po	5.4	—	—	mW
Total Power LED56(7)	I _F = 100 mA	Po	1.5	—	—	mW
Rise Time 0-90% of output		t _r	—	1.0	—	μs
Fall Time 100-10% of output		t _f	—	1.0	—	μs

 P_D

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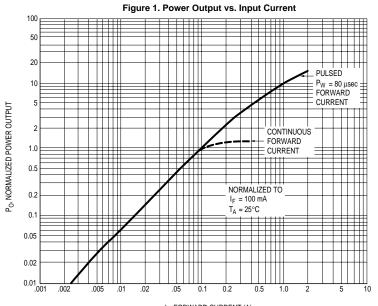


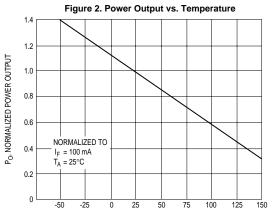
GaAs INFRARED EMITTING DIODE

LED55C LED55B

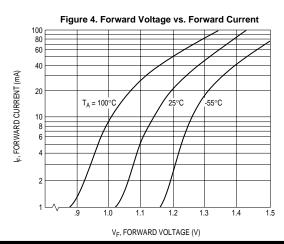
LED56

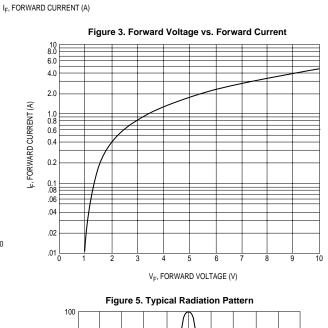
TYPICAL PERFORMANCE CURVES

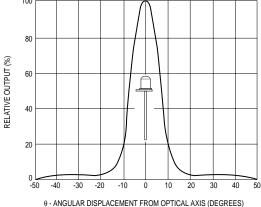




T_A, AMBIENT TEMPERATURE (°C)









GaAs INFRARED EMITTING DIODE

LED55B LED55C LED56

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- 2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.